IRFZ14

Vishay Siliconix



TO-220AB

PRODUCT SUMMARY

V_{DS} (V)

 $R_{DS(on)}(\Omega)$

Q_{gs} (nC)

Q_{gd} (nC)

Q_a (Max.) (nC)

Configuration

Power MOSFET

FEATURES

- Dynamic dV/dt rating
- 175 °C operating temperature
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

S

N-Channel MOSFET

0.20

60

11

3.1

5.8

Single

 $V_{GS} = 10 V$

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRFZ14PbF
Lead (Pb)-free and halogen-free	IRFZ14PbF-BE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, un	less otherwis	se noted)			
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-source voltage ^f			V _{DS}	60	N	
Gate-source voltage ^f			V _{GS}	± 20	V	
Continuous drain current	V at 10 V	T _C = 25 °C		10		
Continuous drain current	$V_{GS} \text{ at } 10 \text{ V} \qquad T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	ID	7.2	А		
Pulsed drain current ^a		I _{DM}	40]		
Linear derating factor			0.29	W/°C		
Single pulse avalanche energy ^b			E _{AS}	47	mJ	
Maximum power dissipation	T _C = 25 °C		PD	43	W	
Peak diode recovery dV/dt ^c			dV/dt	4.5	V/ns	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +175	- °C	
Soldering recommendations (peak temperature)	For 10 s			300 ^d	7	
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
				1.1	N·m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. V_{DD} = 25 V; starting T_J = 25 °C, L = 1.47 mH, R_g = 25 Ω , I_{AS} = 8 A (see fig. 12)

c. $I_{SD} \le 10$ A, dl/dt ≤ 90 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C

d. 1.6 mm from case



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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	62	
Case-to-sink, flat, greased surface	R _{thCS}	0.50	-	°C/W
Maximum junction-to-case (drain)	R _{thJC}	-	3.5	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					I	L	1
Drain-source breakdown voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μΑ	60	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.063	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Gate-source leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
		V _{DS}	= 60 V, V _{GS} = 0 V	-	-	25	μA
Zero gate voltage drain current	I _{DSS}	V _{DS} = 48 V	, V _{GS} = 0 V, T _J = 150 °C	-	-	250	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 6.0 A ^b	-	-	0.20	Ω
Forward transconductance	9 _{fs}	V _{DS} =	= 25 V, I _D = 6.0 A ^b	2.4	-	-	S
Dynamic							
Input capacitance	C _{iss}		$V_{ee} = 0.V$	-	300	-	
Output capacitance	C _{oss}			-	pF		
Reverse transfer capacitance	C _{rss}			-			
Total gate charge	Qg			-	-	11	
Gate-source charge	Q _{gs}	V _{GS} = 10 V		-	-	3.1	nC
Gate-drain charge	Q _{gd}			-	-	5.8	
Turn-on delay time	t _{d(on)}		•	-	10	-	
Rise time	t _r		= 30 V, I _D = 10 A,	-	50	-	
Turn-off delay time	t _{d(off)}	R _g =	24 Ω, $R_D = 2.7 \Omega$, see fig. 10 ^b	-	13	-	ns
Fall time	t _f			-	19	-	
Internal drain inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	
Internal source inductance	L _S			-	7.5	-	nH
Drain-Source Body Diode Characteristic	cs					•	
Continuous source-drain diode current	I _S	MOSFET sym showing the	bol	-	-	10	А
Pulsed diode forward current ^a	I _{SM}	integral reverse p - n junction diode		-	-	40	
Body diode voltage	V_{SD}	T _J = 25 °C	C, $I_{S} = 10 \text{ A}, V_{GS} = 0 \text{ V}^{b}$	-	-	1.6	V
Body diode reverse recovery time	t _{rr}	T 25 °C I	= 10 A, dl/dt = 100 A/µs ^b	-	70	140	ns
Body diode reverse recovery charge	Q _{rr}	$1_{\rm J} = 23$ C, I _F	$= 10 \text{ A}, \text{ u/ut} = 100 \text{ A/}\mu\text{S}^{2}$	-	0.20	0.40	μC
Forward turn-on time	t _{on}	Intrinsic tu	ırn-on time is negligible (turn	-on is dor	minated b	y L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width $\leq 300~\mu s;~duty~cycle \leq 2~\%$

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

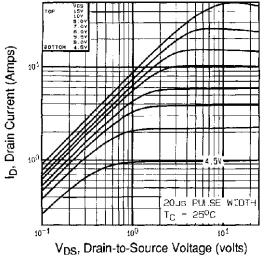


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

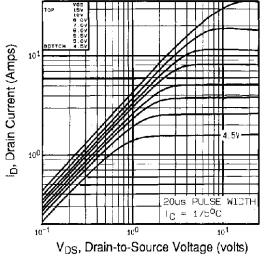


Fig. 2 - Typical Output Characteristics, T_C = 175 °C

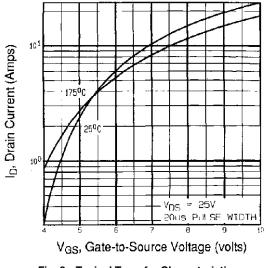


Fig. 3 - Typical Transfer Characteristics

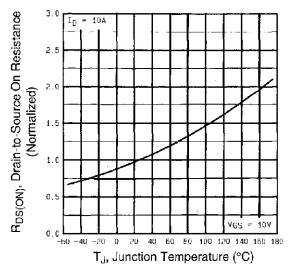
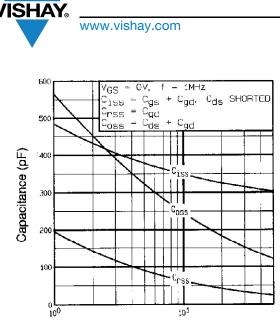


Fig. 4 - Normalized On-Resistance vs. Temperature

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V_{DS}, Drain-to-Source Voltage (volts)

Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

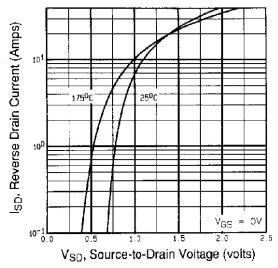


Fig. 7 - Typical Source-Drain Diode Forward Voltage

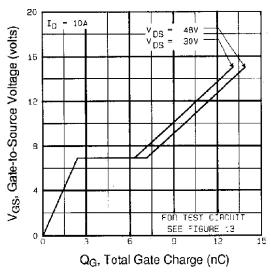
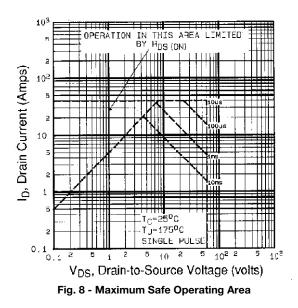


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



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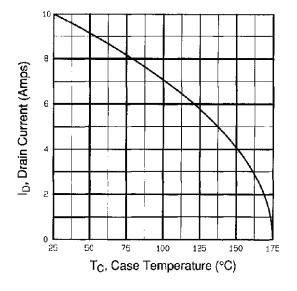


Fig. 9 - Maximum Drain Current vs. Case Temperature

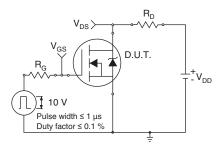


Fig. 10 - Switching Time Test Circuit

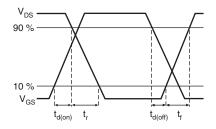


Fig. 11 - Switching Time Waveforms

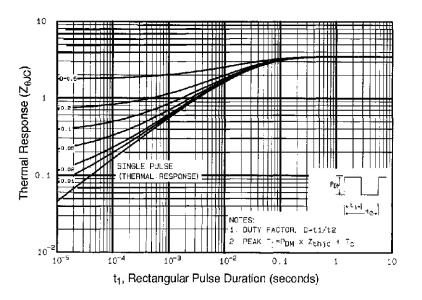
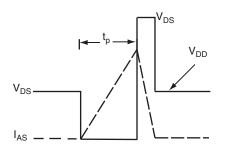


Fig. 12 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



Vary t_p to obtain required I_{AS} R_G I_{AS} I_{AS} I_{AS} I_{AS} U.U.T I_{AS} U.U.T

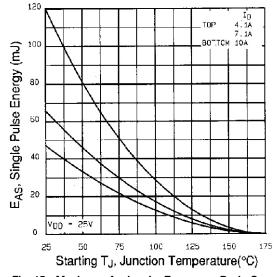
Fig. 13 - Unclamped Inductive Test Circuit



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Fig. 14 - Unclamped Inductive Waveforms





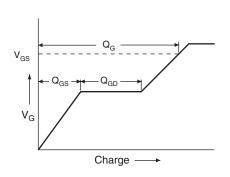


Fig. 16 - Basic Gate Charge Waveform

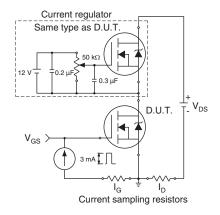
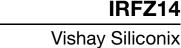


Fig. 17 - Gate Charge Test Circuit

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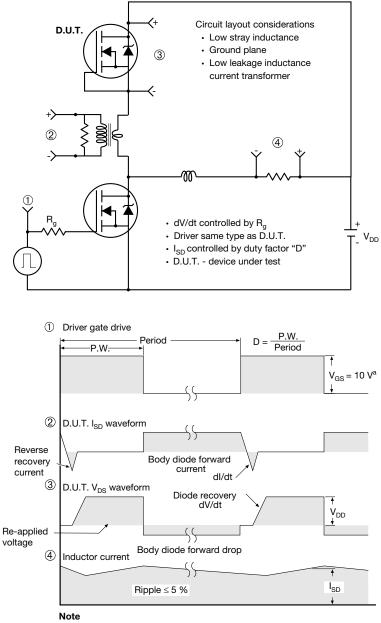
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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TO-220-1



DIM	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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